

07-31-2001



Tab settings

To the Honorable Commission 101792321

record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Ichiro TAKAHASHI
Seigo KUROKAWA 7-18-01
Tatsuhiko ASANO
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):
Name: HITACHI, LTD
Internal Address: 6, Kanda Surugadai 4-chome

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other

Street Address: Chiyoda-ku
City: Tokyo, JAPAN State: ZIP:

Execution Date: June 22, 2001

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is:
A. Patent Application No.(s) 09/810,581, filed March 19, 2001
B. Patent No.(s)
Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP
Internal Address: 1300 North 17th Street - Suite 1800
Street Address:
City: Arlington State: VA ZIP: 22209

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 3.41) \$ 40.00
 Enclosed
 Authorized to be charged to deposit account
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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Carl I. Brundidge, Reg. No. 29,621 July 18, 2001
Name of Person Signing Signature Date
Total number of pages including cover sheet, attachments, and document: 3

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Washington, D.C. 20231

(Form PTO--1595--Recordation Form Cover Sheet - page 1 of 3)

07/24/2001 BNGUYEN1 00000024 09810501

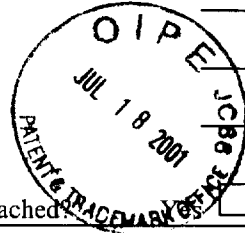
03 FC:581

40.00 DP

PATENTS ONLY

1. Name of conveying party(ies):

Hiromitsu KANEKO



Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):

Name: HITACHI KEIYO ENGINEERING CO., LTD.

Internal Address: 1-1 Higashinarashino 7-chome

Street Address: Narashino-shi

City: Chiba-ken, JAPAN State: _____ ZIP: _____

Name: _____

Internal Address: _____

Street Address: _____

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

E5914-01(2)

ASSIGNMENT

(讓渡証)

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to Ichiro TAKAHASHI, Seigo KUROKAWA, Tatsuhiko ASANO, and Hiromitsu KANEKO, citizens of Japan by HITACHI, LTD., and HITACHI KEIYO ENGINEERING CO., LTD., corporations organized under the laws of Japan,

located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, and 1-1, Higashinarashino-7-chome, Narashino-shi, Chiba-ken, Japan, respectively,

receipt of which is hereby acknowledged, we, the said Ichiro TAKAHASHI, Seigo KUROKAWA, Tatsuhiko ASANO, and Hiromitsu KANEKO,

do hereby sell and assign to said HITACHI, LTD., and HITACHI KEIYO ENGINEERING CO., LTD.,

their successors and assigns, all our right, title and interest, in and for the United States of America, in and to INSTRUMENTS MANAGEMENT SYSTEM AND METHOD AND MONITORING APPARATUS, DATA BASE APPARATUS AND DATA BASE CLIENT APPARATUSES AND RECORDING MEDIUM

*U.S. Serial No. 09/810,581 filed on March 19, 2001

invented by us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., and HITACHI KEIYO ENGINEERING CO., LTD.,

their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD., and HITACHI KEIYO ENGINEERING CO., LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed

(署名日)

- | | | |
|-----|---|----------------------|
| 1) | <u>Ichiro Takahashi</u>
Ichiro TAKAHASHI | <u>June 22, 2001</u> |
| 2) | <u>Seigo Kurokawa</u>
Seigo KUROKAWA | <u>June 22, 2001</u> |
| 3) | <u>Tatsuhiko Asano</u>
Tatsuhiko ASANO | <u>June 22, 2001</u> |
| 4) | <u>Hiromitsu Kaneko</u>
Hiromitsu KANEKO | <u>June 22, 2001</u> |
| 5) | _____ | _____ |
| 6) | _____ | _____ |
| 7) | _____ | _____ |
| 8) | _____ | _____ |
| 9) | _____ | _____ |
| 10) | _____ | _____ |